×	06-21-2001			
FOR. PTO-1594 (Rev. t-93)  Atty Docket #:		EET	U.S. DEPARTMENT OF COMMERCE Patent and	
ONS00167	101755071		Trademark Office	
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.				
Name of conveying part(ies):	2. Title of invention			
Philippe Goyhenetche	P / POWER SUI	POWER SUPPLY CIRCUIT AND METHOD		
Dominique Omet				
Christophe Basso				
			)(IN	
3. Nature of conveyance:	4. Name: Semi	conductor Compo	nents Industries, LLC	
		Patent Administration Dept MD A230		
Security Agreement Change of		P.O. Box 62890 Phoenix, AZ 85082-2890		
Other	1.0.			
Other	<u>I noci</u>	IIX, AZ 65002-20	<u> </u>	
Execution date of March 23, 20	O1 Additional name(s) & a	ddress(es) attached?	Yes No	
conveyance in March 30, 20	01			
order of inventor:  March 30, 20	01			
5. Application number(s) or patent number(s				
If this document is being filed together with a of inventor of the application is:	n new application, the execution d	ate in order		
A. Patent Application No.(s):	B. Patent No.(s):			
09/821,988				
	Additional numbers attached?	Yes	⊠ No	
6. Name and address of party to whom correst concerning document should be mailed:	6. Total number of	6. Total number of applications and patents involved: 1		
Name: <u>ON Semiconductor</u>	8. Total fee (37 C.I	F.R. 3.41)	\$ <u>40.00</u>	
Internal Address: Patent Administration MD A230	on Dept - Enclosed			
Street Address: P.O. Box 62890	Authorized to	Authorized to be charged to deposit account		
City, State, Zip: Phoenix, AZ 85082	9. Deposit account	number: 501086		
	DO NOT USE THIS SPACE			
10. Statement and signature. To the best of my knowledge and belief, the original document.	foregoing information is true and	correct and any attach	ned copy is a true copy of the	
Michael T. Wallace	45,420	1-111		
	Muchae	I (Wallace	x 5-24-01	
Name of Person Signing	Reg. No. Signature		Date	
Total number of pages including cover sheet, attachments, and document: 5				
OMB No. 0651-0011 (exp. 4/94)				
; 21/2001 LMUELLER 00000043 501086 09821988	1			
FC:581 40.00 CH				
10:301 40:00 CH				

**PATENT** 

**REEL: 011899 FRAME: 0525** 

## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, Philippe Goyhenetche of Fonsorbes, France; Dominique Omet of Cugnaux, France; and Christophe Basso of Pibrac, France, have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a Limited Liability Company of the State of Delaware, doing business as ON Semiconductor, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in POWER SUPPLY CIRCUIT AND METHOD (Attorney Docket No. ONS00167), described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient

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We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Philippe Goyhenetche

Witnessed on this Date: 03-23-2001

By Printed Name: Jose M. Capilla

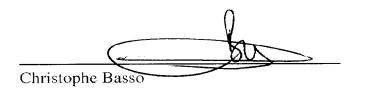
Signature:

**PATENT** REEL: 011899 FRAME: 0527 Dominique Omet

Witnessed on this Date: 03-30-2001

By Printed Name: José M. Capilla
Signature:

**PATENT REEL: 011899 FRAME: 0528** 



**RECORDED: 06/01/2001** 

Signature:

**PATENT REEL: 011899 FRAME: 0529**